

CUSTOMER 客户:

规格书编号

SPEC NO:

产品规格书 SPECIFICATION

PRODUCT 产品:	SAW RESONATOR						
MODEL NO 型 号:	HDR316.2M-F11D						
PREPARED 编 制:	CHECKED 审 核:						
APPROVED 批 准:	DATE 日 其	月:2009-11-12					
客户确认 CUSTOMER RECEIVED:							
审核 CHECKED	批准 APPROVED	日期 DATE					

无锡市好达电子有限公司 Shoulder Electronics Limited

备注

Remark



更改历史记录

更改日期 Date 规格书编号 Spec. No. 产品型号 Part No. 客户产品型号 Customer No. 更改内容描述 Modify Content



1. SCOPE

This specification shall cover the characteristics of 1-port SAW resonator with 316.2M used for remote-control security.

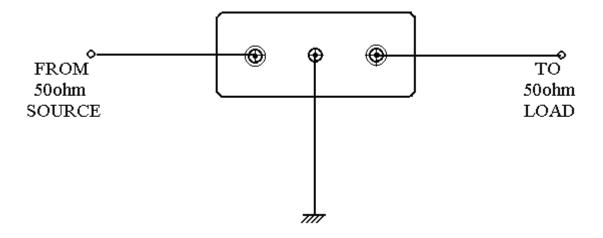
2. ELECTRICAL SPECIFICATION

DC Voltage VDC	10V		
AC Voltage Vpp	10V50Hz/60Hz		
Operation temperature	-40°C to +85°C		
Storage temperature	-45°C to +85°C		
RF Power Dissipation	0dBm		

2.2 Electronic Characteristics

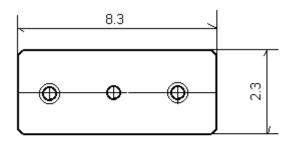
Item		Unites	Minimum	Typical	Maximum
Center Frequency		MHz	316.125	316.200	316.275
Insertion Loss		dB		1.3	2.5
Quality Factor Unload Q			7000	1200	
50 Ω Loaded Q			1000	2000	
Temperature	Turnover Temperature	$^{\circ}\!\mathbb{C}$	10	25	40
Stability	Freq.temp.Coefficient	ppm/°C2		0.032	
Frequency Aging		ppm/yr		≤10	
DC. Insulation Resistance		$\mathbf{M} \Omega$	1.0		
DE Ei1	Motional Resistance R1	Ω		18	26
RF Equivalent RLC Model	Motional Inductance L1	μН		110.98	
	Motional Capacitance C1	fF		2.2818	
Transducer Static Capacitance		pF		2.6	

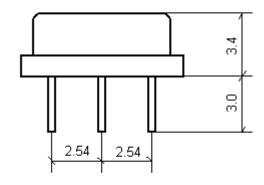
3. TEST CIRCUIT

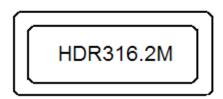




4. DIMENSION







5. ENVIRONMENTAL CHARACTERISTICS

5-1 High temperature exposure

Subject the device to $+85^{\circ}$ C for 16 hours. Then release the resonator into the room conditions for 24 hours prior to the measurement. It shall fulfill the specifications in 2.2.

5-2 Low temperature exposure

Subject the device to -40° C for 16 hours. Then release the device into the room conditions for 24 hours prior to the measurement. It shall fulfill the specifications in 2.2.

5-3 Temperature cycling

Subject the device to a low temperature of -40° C for 30 minutes. Following by a high temperature of $+85^{\circ}$ C for 30 Minutes. Then release the device into the room conditions for 24 hours prior to the measurement. It shall meet the specifications in 2.2.

5-4 Resistance to solder heat

Dip the device terminals no closer than 1.5mm into the solder bath at 260° C $\pm 10^{\circ}$ C for 10 ± 1 sec. Then release the device into the room conditions for 4 hours. The device shall meet the specifications in 2.2.

5-5 Solderability



SAW RESONATOR

HDR316.2M-F11D

Subject the device terminals into the solder bath at 245° C $\pm 5^{\circ}$ C for 5s, More than 95% area of the terminals must be covered with new solder. It shall meet the specifications in 2.2.

5-6 Mechanical shock

Drop the device randomly onto the concrete floor from the height of 1m 3 times. the device shall fulfill the specifications in 2.2.

5-7 Vibration

Subject the device to the vibration for 1 hour each in x,y and z axes with the amplitude of 1.5 mm at 10 to 55 Hz. The device shall fulfill the specifications in 2.2.

6. REMARK

6.1 Static voltage

Static voltage between signal load & ground may cause deterioration &destruction of the component. Please avoid static voltage.

6.2 Ultrasonic cleaning

Ultrasonic vibration may cause deterioration & destruction of the component. Please avoid ultrasonic cleaning

6.3 Soldering

Only leads of component may be soldered. Please avoid soldering another part of component.